## **CLAIMS**

1. A process of reforming a quartz glass crucible, wherein the quartz glass crucible is reformed by an arc discharge generated by electrodes positioned around a rotational axis and configured to heat an inside surface of the crucible while the crucible is rotated, the process comprising:

arranging the electrodes in an electrode structure in which neighboring electrodes are positioned at regular intervals from each other in a ring-like configuration;

forming a stable ring-like arc between the neighboring electrodes, without generating a continuous arc between electrodes facing each other across a central portion of the ring-like configuration;

heating the inside surface of the crucible; and removing one of a foreign substance located on the inside surface and a bubble located under the inside surface.

2. The process of claim 1, wherein the arranging step comprises:

arranging the electrodes in the electrode structure such that the neighboring electrodes are positioned at regular intervals in the ring-like configuration so as to have an absolute value  $\theta$  of a phase difference of alternating electric current in the range of  $90^{\circ} \le \theta \le 180^{\circ}$ .

- 3. The process of claim 1, wherein a radius r of the ring-like configuration around the rotational axis is at least ¼ of a radius R of an open portion of the crucible, for at least a fixed time during arc heating.
  - 4. The process of claim 1, wherein a diameter of the crucible is 28 to 40 inches.
- 5. The process of claim 1, wherein the quartz glass crucible is used for the pulling up of single crystal silicon.
  - 6. The process of claim 2, wherein a diameter of the crucible is 28 to 40 inches.
- 7. The process of claim 2, wherein the quartz glass crucible is used for the pulling up of single crystal silicon.

- 8. The process of claim 2, wherein a radius r of the ring-like configuration around the rotational axis is at least ¼ of a radius R of an open portion of the crucible, for at least a fixed time during arc heating.
  - 9. The process of claim 8, wherein a diameter of the crucible is 28 to 40 inches.
- 10. The process of claim 8, wherein the quartz glass crucible is used for the pulling up of single crystal silicon.
  - 11. The process of claim 3, wherein a diameter of the crucible is 28 to 40 inches.
- 12. The process of claim 3, wherein the quartz glass crucible is used for the pulling up of single crystal silicon.
  - 13. A process of reforming a quartz glass crucible, comprising:

one of mechanically removing a foreign substance on an inside surface of the crucible and removing a bubble just under the inside surface of the crucible by grinding;

arranging electrodes in an electrode structure such that neighboring electrodes are positioned at regular intervals from each other in a ring-like configuration;

forming a ring-like arc between neighboring electrodes; and fusing the inside surface of the crucible to be smoothed.

- 14. The process of claim 13, wherein a diameter of the crucible is 28 to 40 inches.
- 15. The process of claim 13, wherein the quartz glass crucible is used for the pulling up of single crystal silicon.